

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
BEFORE THE BOARD OF PATENT APPEALS AND INTERFERENCES**

In re Patent application of:

Applicant(s): Kai Numssen et al.
Serial No: 10/684,811
Filing Date: October 14, 2003
Title: METHOD FOR MANUFACTURE OF A HIGH TEMPERATURE
SUPERCONDUCTING LAYER

Examiner: Talbot, Brian K
Art Unit: 1762
Docket No. BARDP0124US

**PETITION FOR EXTENSION OF TIME TO FILE REPLY
TO EXAMINER'S ANSWER UNDER 37 CFR 1.136(b)**

Mail Stop Appeal Brief-Patents
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Petition hereby is made for an extension of time of one month, to and including October 3, 2008, in which to file a reply to the Examiner's Answer.

After internal processing and the undersigned being delayed because of other matters in reviewing the Examiner's Answer and reporting same, the undersigned did report the Examiner's Answer via email to the applicants' European patent representative on August 5, 2008. The applicants' European representative now has learned that his client is presently on a business trip and that applicants' European representative will be out of office for the next two weeks. Consequently, it would be very difficult for applicants' European representative to review with his client the Examiner's Answer and provide comments and instructions to the undersigned in respect of a reply to the Examiner's Answer.

The foregoing is believed to constitute sufficient cause for an extension under 37 CFR 1.136(b) and therefore granting of this petition is respectfully requested.

The Commissioner is hereby authorized to charge the petition fee to Deposit Account No. 18-0988 unless already paid by credit card upon the filing of this petition.

Respectfully submitted,

RENNER, OTTO, BOISSELLE & SKLAR, LLP

/Don W. Bulson/

By

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Commissioner for Patents
United States Patent and Trademark Office
Washington, D.C. 20231